

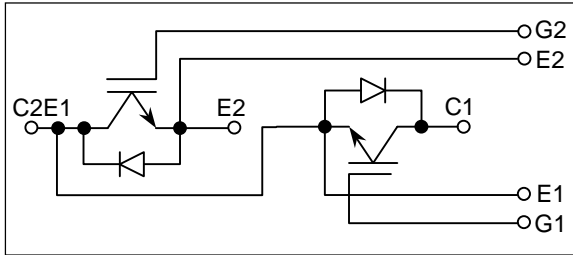
MBM200GR12A

[Rated 200A/1200V, Dual-pack type]

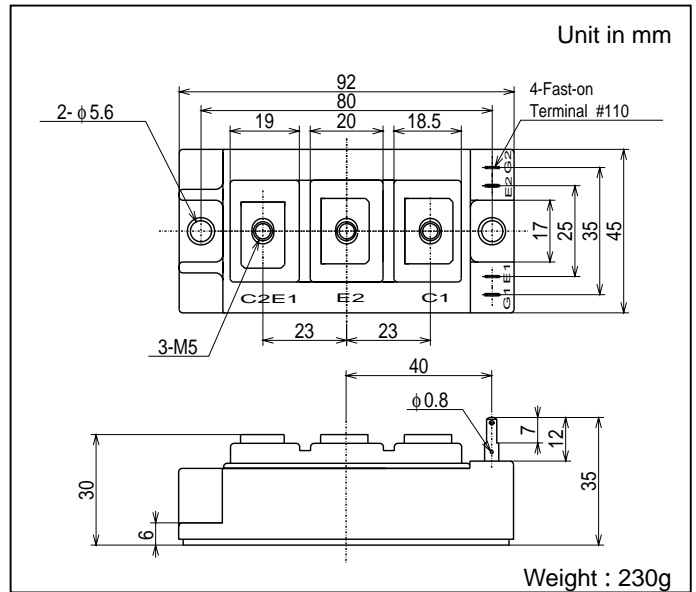
FEATURES

- Low saturation voltage and high speed.
- Low turn-OFF switching loss.
- Low noise due to built-in free-wheeling diode.
(Ultra Soft and Fast recovery Diode (USFD))
- High reliability structure.
- Isolated heat sink (terminals to base).

CIRCUIT DIAGRAM



OUTLINE DRAWING



ABSOLUTE MAXIMUM RATINGS (T_c=25°C)

| Item | Symbol | Unit | Value |
|-----------------------------|------------------|------------------|--------------------|
| Collector-Emitter Voltage | V _{CES} | V | 1200 |
| Gate-Emitter Voltage | V _{GES} | V | ±20 |
| Collector Current | DC | I _C | 200 |
| | 1ms | I _{CP} | 400 |
| Forward Current | DC | I _F | 200 ^{*1} |
| | 1ms | I _{FM} | 400 |
| Collector Power Dissipation | P _C | W | 1250 |
| Junction Temperature | T _j | °C | -40 ~ +150 |
| Storage Temperature | T _{stg} | °C | -40 ~ +125 |
| Isolation Voltage | V _{iso} | V _{RMS} | 2500(AC 1 minute) |
| Screw Torque | Terminals | — | 1.96 ^{*2} |
| | Mounting | | 1.96 ^{*3} |

Notes; *1 : RMS current of diode ≤ 60 Arms

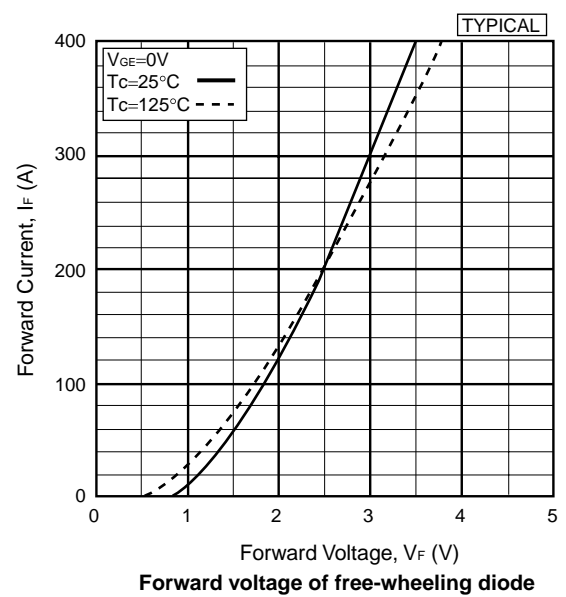
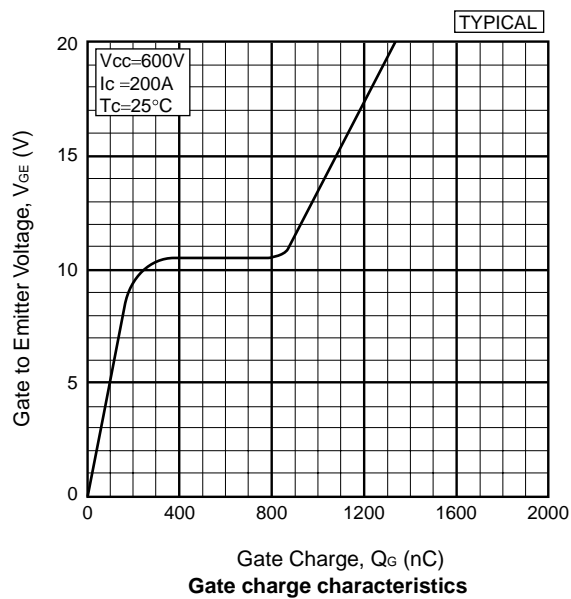
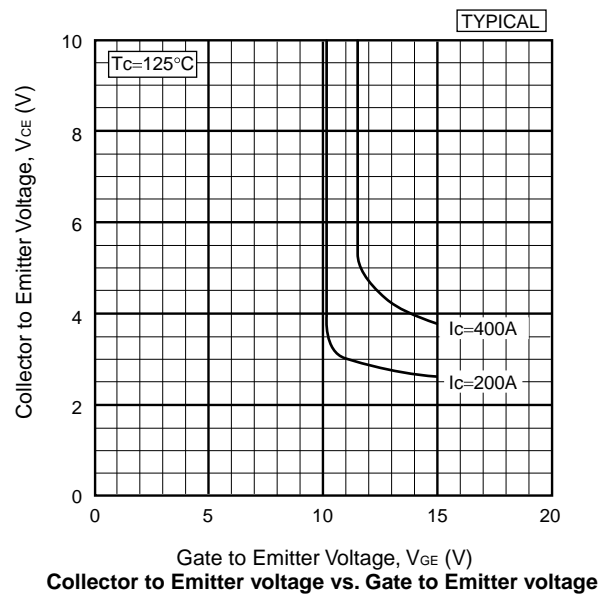
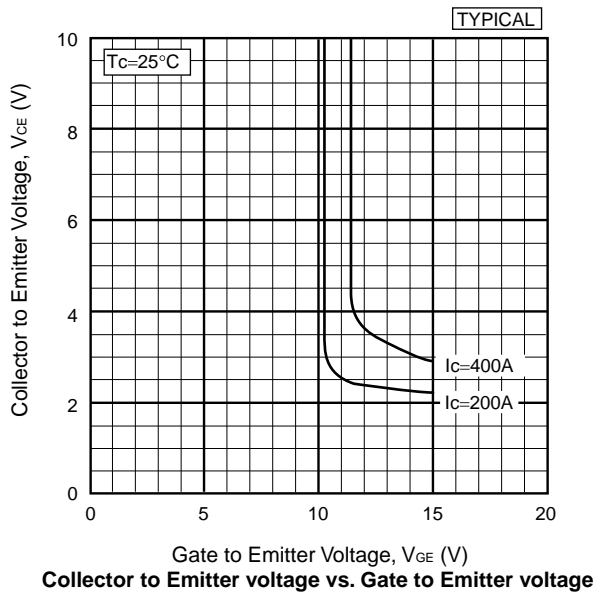
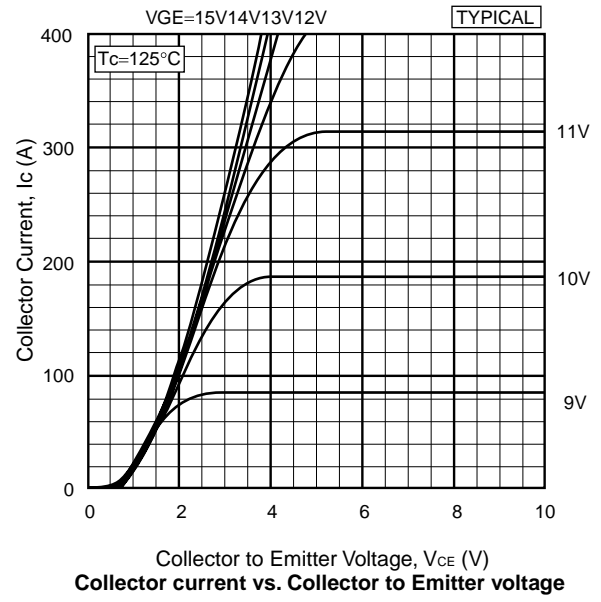
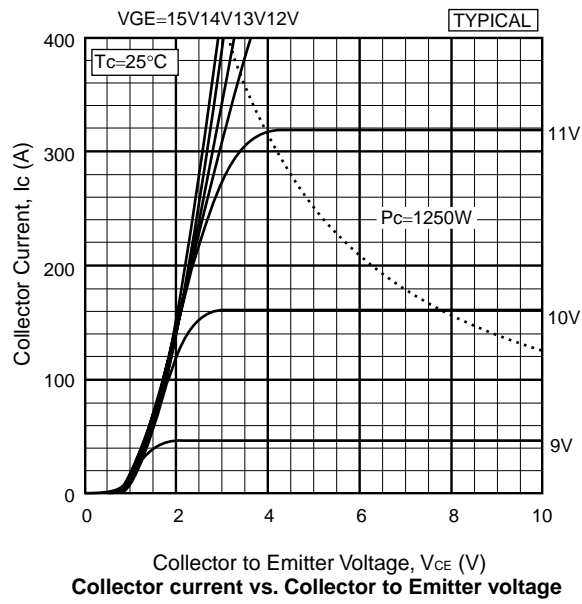
*2, *3 : Recommended value 1.67 N·m

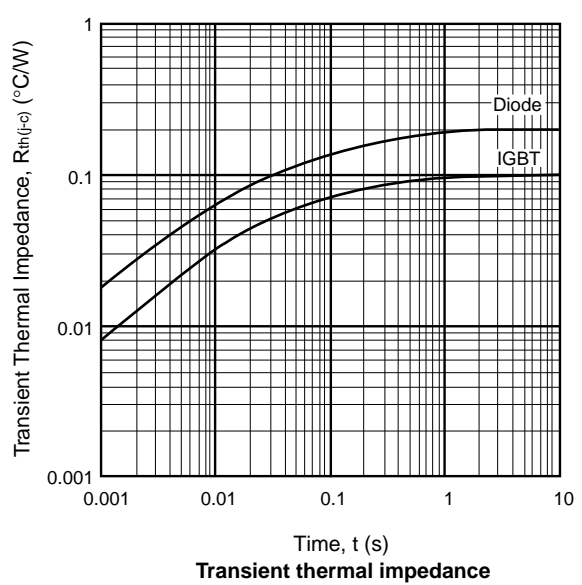
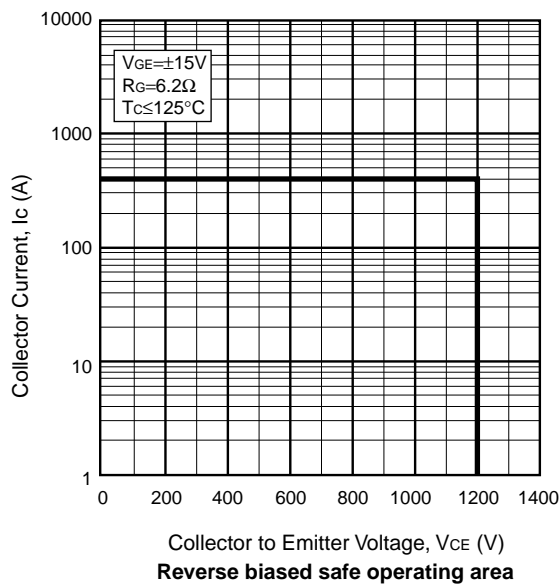
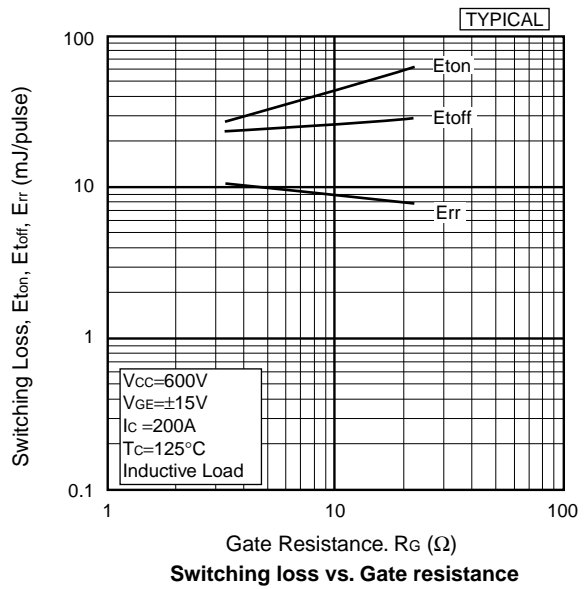
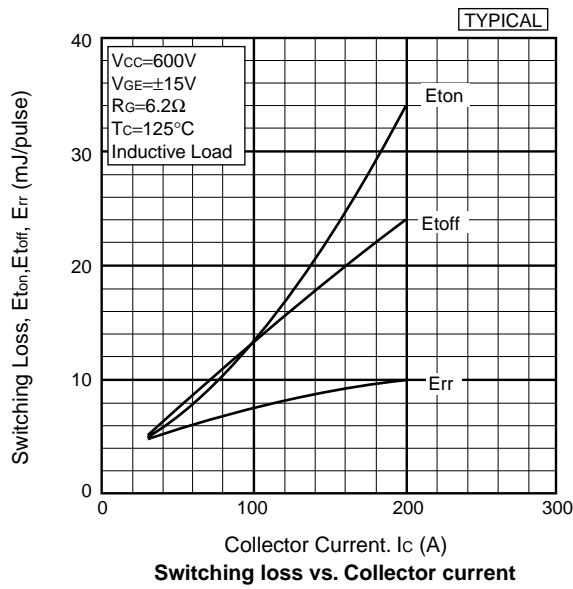
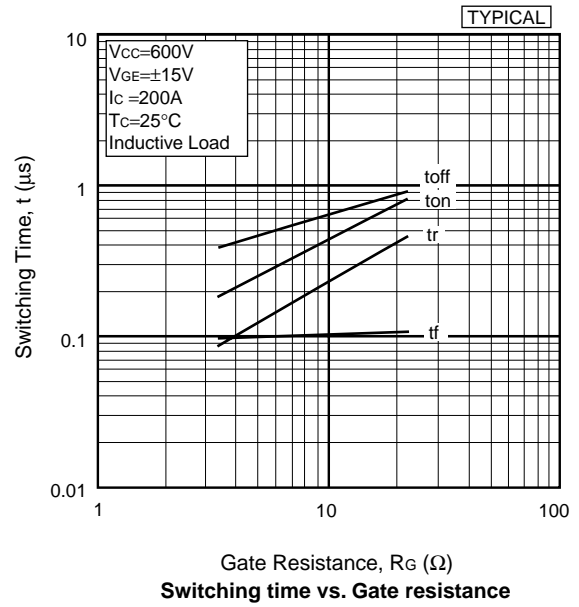
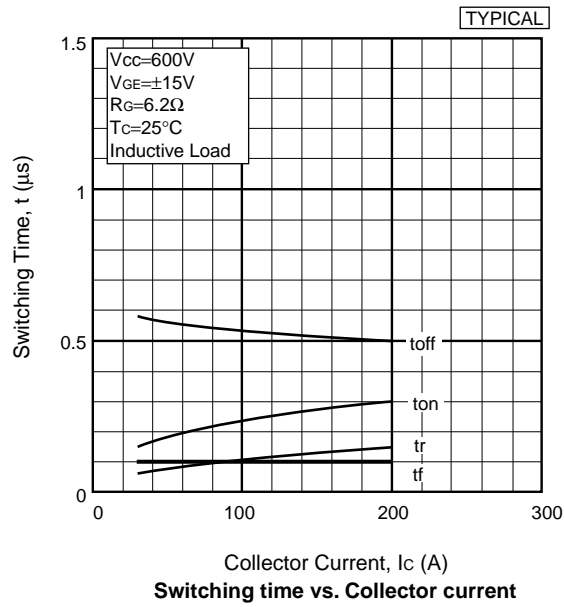
CHARACTERISTICS (T_c=25°C)

| Item | Symbol | Unit | Min. | Typ. | Max. | Test Conditions |
|--------------------------------------|----------------------|----------------------|------|-------|------|--|
| Collector-Emitter Cut-Off Current | I _{CES} | mA | — | — | 1.0 | V _{CE} =1200V, V _{GE} =0V |
| Gate-Emitter Leakage Current | I _{GES} | nA | — | — | ±500 | V _{GE} =±20V, V _{CE} =0V |
| Collector-Emitter Saturation Voltage | V _{CE(sat)} | V | — | 2.2 | 2.8 | I _C =200A, V _{GE} =15V |
| Gate-Emitter Threshold Voltage | V _{GE(TH)} | V | — | — | 10 | V _{CE} =5V, I _C =200mA |
| Input Capacitance | C _{ies} | pF | — | 18000 | — | V _{CE} =10V, V _{GE} =0V, f=1MHz |
| Switching Times | Rise Time | t _r | — | 0.15 | 0.3 | V _{CC} =600V, I _C =200A ^{*4} R _G =6.2Ω V _{GE} =±15V Inductive Load I _F =200A |
| | Turn-On Time | t _{on} | — | 0.3 | 0.6 | |
| | Fall Time | t _f | — | 0.1 | 0.3 | |
| | Turn-Off Time | t _{off} | — | 0.5 | 1.0 | |
| Reverse Recovery Time | t _{rr} | μs | — | 0.2 | 0.4 | |
| Peak Forward Voltage Drop | V _{FM} | V | — | 2.5 | 3.5 | I _F =200A, V _{GE} =0V |
| Thermal Impedance | IGBT | R _{th(j-c)} | °C/W | — | 0.1 | Junction to case |
| | FWD | R _{th(j-c)} | | | 0.2 | |

Notes; *4 : R_G value is the test condition's value for decision of the switching times, not recommended value, please determine the suitable R_G value after the measurement of switching waveforms (overshoot voltage, etc.) with appliance mounted.

Remark; For actual application, please confirm this spec. sheet is the newest revision.





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